Israel Section

Shmuel Auster

List the activities carried out to foster relations with Industry and the results obtained. List the initiatives planned during the next 6 months and their expected outcomes. How can the Region help your Section in your industry-related activities?

IEEE COMCAS 2019 held in 4-6 Nov. 2019 in Tel Aviv was most successful, with over 1900 attendees, most of them from the Industry and large Industry exhibition (100 booths). We had 216 presentations and 72 top level invited speakers. in the coming 6 months we will have IEEE SA workshops (with Industry presentations, these days (end of January 2020), Bio Medical Engineering Conference in Haifa in 2.2020, Antennas Symposium in TAU (Tel Aviv) in 3.2020, EMC Conference in Ashdod (May 2020) and more, all with Academia and Industry speakers and participants. R8 can help with advertising and with top level speakers.

List the activities addressed to Students and/or Young Professionals and the results obtained. List the initiatives planned during the next 6 months and their expected outcomes. How can the Region help in your students and YP-related activities?

Our IEEE YP and students affiliated groups are very active. We have just had a successful Students and YP meeting at the Technion (end of December 2019), organized by Aleks Dyskin, the YP AG chair, with over 120 attendees, and we plan the next meetings for 2020. These meetings were and will be organized at the Tel Aviv University, Technion, Bar Ilan University, Hebrew University in Jerusalem and the BGU at the Negev (south).

List the activities carried out to retain and recruit members and the results obtained. List the initiatives planned during the next 6 months and their expected outcomes. How can the Region help in your membership-related activities?

We have established the Electronic Packaging, Thermal Management and Reliability forum and will establish shortly EPS chapter, and many members of this attractive forum joined IEEE and IEEE EPS as new members to establish the new EPS chapter! We also take care to follow the chapters activities, with financial and guidance support from the section, and have replaced chapter chairs with new energetic chairs, where needed.

List the activities intended to support chapters, affinity groups, and student branches and the results obtained. List the related initiatives planned during the next 6 months and their expected outcomes. How can the Region help in your support to chapters, affinity groups, and student branches?

I described most of it in previous paragraphs. We have established the Electronic Packaging, Thermal Management and Reliability forum and will establish shortly EPS chapter, and many members of this attractive forum joined IEEE and IEEE EPS as new members to establish the new EPS chapter! We also take care to follow the chapters activities, with financial and guidance support from the section, and have replaced chapter chairs with new energetic chairs, where needed. in the coming 6 months we will have IEEE SA workshops (with Industry presentations, these days (end of January 2020), Bio Medical Engineering Conference in Haifa in 2.2020, Antennas Symposium in TAU (Tel Aviv) in 3.2020, EMC Conference in Ashdod (May 2020) and more, all with Academia and Industry speakers and participants. We have had elections for all positions (section’s board and management). Results will be announced soon.

Challenges (with a focus on what support is required from Region 8)

We plan to establish new chapters, increase technical and social activities of chapters and affiliated groups, and discuss with IEEE on corporate membership.
Thank You

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and the TPC Co-Chairs: Steve Weinstein, Caleb Faison, Amir Landesberg, Arie Yeredor,
Naveen Bhat, Abraham Duskin, Yudin Itskah, Gennady Ziklin, Oren Eliezer

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and all the participants